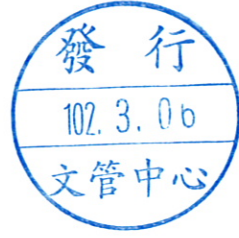




RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A0	Release To Production	2010.08.11	Ivy
A1	ECN20130202	2013.02.26	Seven



Specification

- 1.Current Rating:5A
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:10mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:AC1500V/Minute
- 6.Operating Temperature:-25℃~+85℃

Material:

- 1.Housing:Thermoplastic UL94V-2
- 2.Contact Pin:Copper Alloy $\phi 0.16\text{mm}$

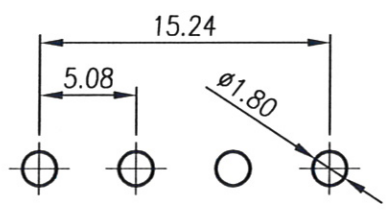
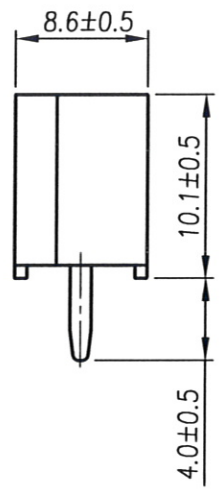
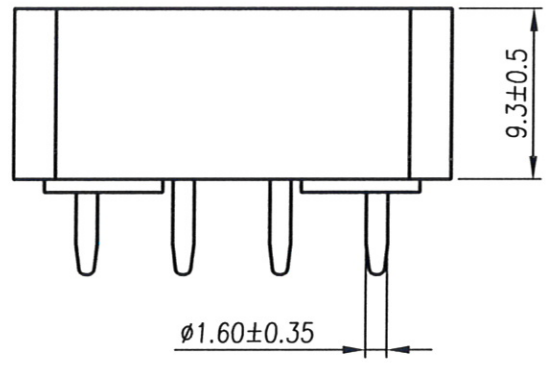
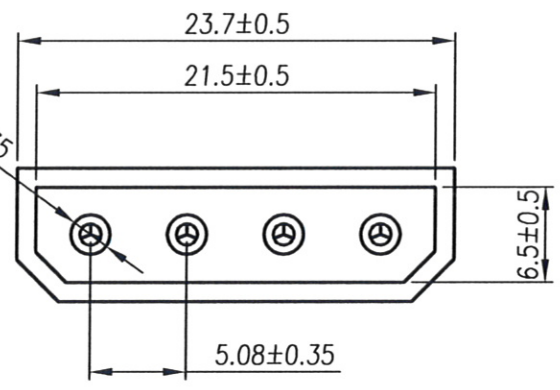
Finish:

- 1.Housing:Natural
- 2.Contact Pin:Bright Tin Plated Over Nickel.

Part No.: AD00500 04 0 1 5 2

Number of Pin Packing
 04 5:Bag

Housing Material Plating
 0:NY66 UL94V-2 Natural 1:Bright Tin Plated Over Nickel.



RECOMMENDED PCB LAYOUT
(Tolerance:±0.05)

金上達科技股份有限公司
GOLDENSUNDA TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 5.08mm 180° 4P DIP			
.x± 0.35	x.*± 2'	APR. Jay 20130226	PART NO. AD00500040152		DWG NO. AD00500040152	
.xx± 0.25	.x.*± 1'	CHK. Michelle 20130226	UNITS: mm	CUSTOMER DRAWING		
.xxx± 0.15	.xx.*± 0.5'	DRA. Seven 20130226	SIZE: A4	SCALE 2.5:1	SHEET 1 / 1	
			REV A1	V		